

NOTES:

MATERIAL:

1. HOUSING MATERIAL :GLASS FILLED POLYESTER UL94V-0.
2. CONTACT MATERIAL :PHOSPHOR BRONZE $\phi=0.46\text{mm}$.
3. PLATING :SELECTING GOLD PLATING $3\mu\sim 50\mu\text{O}$ NICKEL

ELECTRICAL:

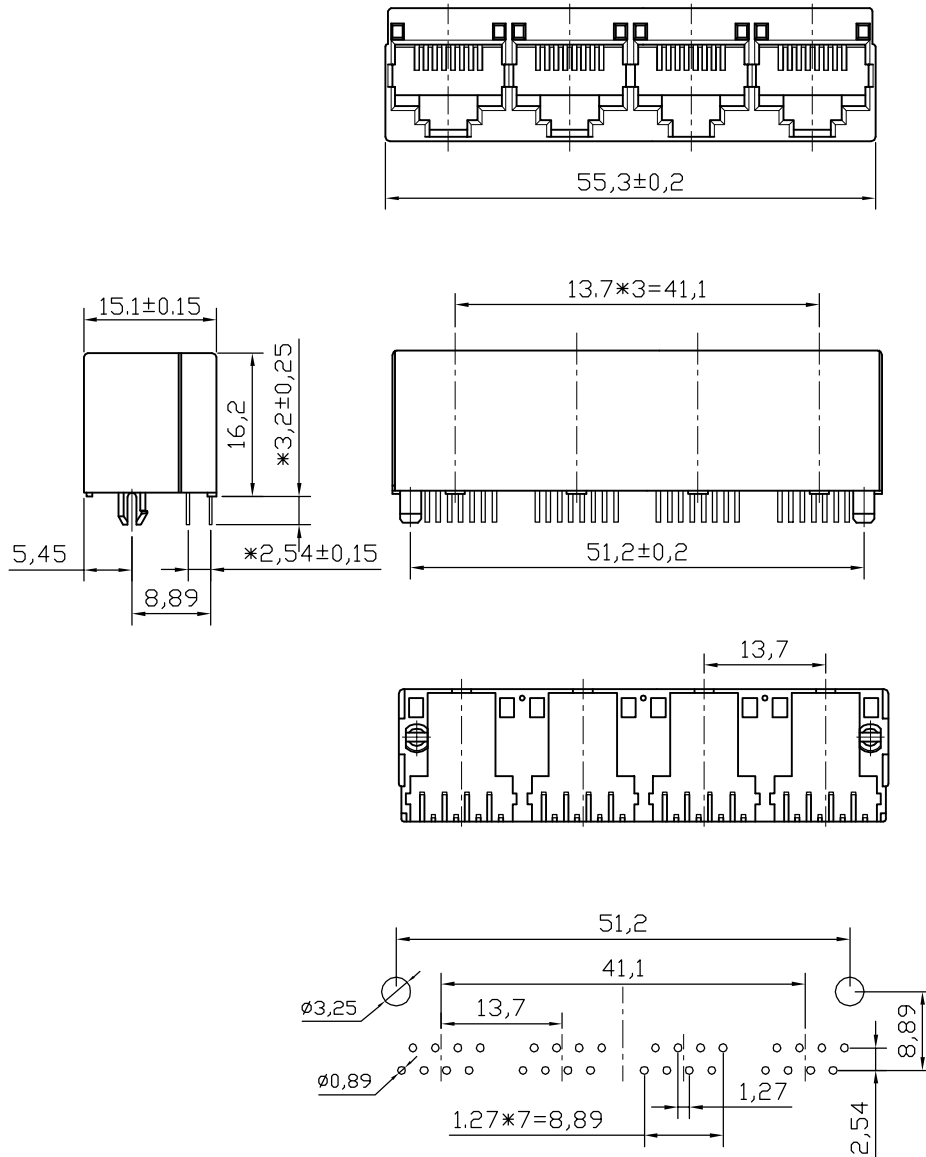
1. VOLTAGE RATING :125 VAC RMS.
2. CURRENT RATING :1.5 AMP.
3. CONTACT RESISTANCE :30 MILLIOHMS MAX.
4. INSULATION RESISTANCE :500 MEGOHMS MIN @ 500V DC .
5. DIELECTRIC WITHSTANDING RESISTANCE :1000V AC RMS 50Hz. 1MIN.

MECHANICAL:

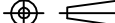
1. DURRABILITY: :750 CYCLES MIN.
2. PCB RETENTION PRE-SOLDER :1 LB MIN.

ENVIRONMENTAL:

1. STORAGE : -40° C TO 85° C.
2. OPERATION : 0° C TO 70° C.



PC Board Layout
Component Side Shown

DETACHED LISTS	MM CINCH		DFTO: SHB	DATE: 2007.05.05	Coorle Technology	
	TOLERANCES EXCEPT AS NOTED		CHKD: LANBD	DATE: 2007.05.05		
	MM		MFO:	DATE:	TITLE	
	0 ± 0.15	±	APPL:	DATE:		
	.00 ± 0.075	±	MATERIAL :			
	.000 ± 0.05	±	QTY :		DRAWING NO. TE52E1003	
	ANGLES ± 0.5		FINISH :		/PART NO.	
			SCALE :		DO NOT SCALE DRAWING	
	THIRD ANGLE PROJECTION				SHEET X OF	